| | 2 | 3 4 | | 5 | 6 | | f | | 8 |
|--|---|-----------------------|-------------|--|--|--|---------------------------------|---------------------------|--|
| HARTING | DIN power male connector RoHS/cFILes | | | Soldering instructions The connectors should be protected when being soldered in a dip, flow or film soldering baths. Otherwise, they might become contaminated as a result of soldering operations or deformed as a result of overheating. | | | | | |
| | | | | | | | | | |
| General information | | · | | (1) For prototypes and sho | rt runs protect the connectors wi | th an industrial adhesive ta | ipe, e.g. Tesaband 4331 | (www.tesa.de). Co | ver the underside |
| | | | | of the connector moulding soldering apparatus from a | and the adjacent parts of the pcb lamaging the connector. About 140 | as well as the open sides + 5 mm of the tape should | of the connector. This suffice. | will prevent heat | and gases of the |
| Design | IEC 60603-2 | types: F male | | | s recommended. Its protective cove | | | olds the connector | es from ans and |
| No. of contacts | max. 48 | | | heat generated by the sol | dering apparatus. As an additional | protection a foil can be us | ed for covering the par | rts that should no | ot be soldered. |
| Contact spacing | 5,08 mm | 2500// | | | | | | | |
| Test voltage Contact resistance | 1550V contact/contact max. 15mOhm | 2500V contact/ground | | Cross section of solder pi | 1S | | | | |
| Insulation resistance | min. 10120hm | | | ام | , | | | | |
| Working current | max. 6A at 20°C (see derating diagram) | | | 0,29 | - 0,34 mm ² | | | | |
| Temperature range | -55°C +125°C | | , | 0,6 | | | | | |
| Termination technology | solder pins | | | 1 1 1/2/ 1 | | | | | |
| Clearance | min. 1,6 mm | | | | 0.5 | | | | |
| Creepage | min. 3,0 mm | | | 0,53±0, | <u> </u> | | | | |
| Insertion and withdrawal force | 32-pole max. 50N | | | | | | | | |
| | 48-pole max. 75N | | | | | | | | |
| Mating cycles | - PL1 acc. to IEC 60603-2 => | 500 mating cycles | | | | | | | |
| | - PL2 acc. to IEC 60603-2 => | 400 mating cycles | | | | | | | |
| 10. 69 | - PL3 acc. to IEC 60603-2 => | 50 mating cycles | | | | | | | |
| UL file | E102079 | | | | | | | | |
| RoHS - compliant Leadfree | Yes Yes | | | | | | | | |
| | No Yes | | | | | | | | |
| Hot plugging • | 110 | | | - | | | | | |
| Insulator material | | | | | | | | | |
| Material | PBT (thermoplastics, glass fiber reinfor | cement 30%) | | | | | | | |
| Colour | RAL 7032 (grey) | | | | | | | | |
| UL classification | UL 94-V0 | | | | | | | | |
| M 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 | III /475 CTL (00) | | | I | | | | | |
| Material group acc. to IEC 60664-1 | IIIa (175 <u><</u> CTI < 400) | | | · | | | | | |
| Material group acc. to IEC 60664-1 NFF classification | IIIa (175 <u><</u> CTI < 400) 13, F4 | | | | | | | | |
| | | | | | | | | | |
| NFF classification | | | | | | | | | |
| NFF classification Contact material | 13, F4 | | | | | | | | |
| NFF classification Contact material Contact material | Copper alloy | | | • | | | | | |
| NFF classification Contact material Contact material Plating termination zone Plating contact zone | Copper alloy Sn over Ni Au over PdNi over Ni | | | | | | | | |
| NFF classification Contact material Contact material Plating termination zone | Copper alloy Sn over Ni Au over PdNi over Ni | A | | | | | | | |
| NFF classification Contact material Contact material Plating termination zone Plating contact zone | Copper alloy Sn over Ni Au over PdNi over Ni ent carrying capacity) | 6 | | | | | | | |
| NFF classification Contact material Contact material Plating termination zone Plating contact zone Denating diagram acc. to IEC 60512-5 (Curron temperature of materials for inserts and contemporations) | Copper alloy Sn over Ni Au over PdNi over Ni ent carrying capacity) maximum contacts including | 6 5 | | | | | | | |
| Contact material Contact material Plating termination zone Plating contact zone Derating diagram acc. to IEC 60512-5 (Curron termination) The current carrying capacity is limited by temperature of materials for inserts and contact terminals. The current capacity curve is valid for contineering terminated to contacts of contineering terminated t | Copper alloy Sn over Ni Au over PdNi over Ni ent carrying capacity) maximum contacts including thinuous, non enectors when | 6 5 | | All Dimens | ions in mm Scale Free size | : tol. | Ref. | | |
| Contact material Contact material Plating termination zone Plating contact zone Derating diagram acc. to IEC 60512-5 (Current carrying capacity is limited by temperature of materials for inserts and contacts according to the current capacity curve is valid for continuity interrupted current loaded contacts of consimultaneous power on all contacts is given | Copper alloy Sn over Ni Au over PdNi over Ni ent carrying capacity) maximum contacts including thinuous, non enectors when | 6 [V] pe 4 [V] | | All Dimens | | : tol. | | S 09 06 120 02 01 / EC04: | 319 / 24.01.2012 |
| Contact material Contact material Plating termination zone Plating contact zone Derating diagram acc. to IEC 60512-5 (Current carrying capacity is limited by temperature of materials for inserts and contacts are consimultaneous power on all contacts is given the maximum temperature. | Copper alloy Sn over Ni Au over PdNi over Ni ent carrying capacity) maximum contacts including stinuous, non enectors when n, without exceeding | 6 [V] pe 4 [V] | | | ze DIN A3 1:1 eserved Created by | Inspected by Stand | Sub. DS dardisation Date | Sta | ate |
| Contact material Contact material Plating termination zone Plating contact zone Derating diagram acc. to IEC 60512-5 (Current carrying capacity is limited by temperature of materials for inserts and contacts according to the current capacity curve is valid for continuity interrupted current loaded contacts of consimultaneous power on all contacts is given | Copper alloy Sn over Ni Au over PdNi over Ni ent carrying capacity) maximum contacts including stinuous, non enectors when n, without exceeding | 6 [V] pe 4 [V] | | All rights r | ze DIN A3 1:1 eserved Created by HAGFMEYERF | | Sub. DS dardisation Date | Sta | ate nal Release |
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| Contact material Contact material Plating termination zone Plating contact zone Derating diagram acc. to IEC 60512-5 (Current carrying capacity is limited by temperature of materials for inserts and contacts are consimultaneous power on all contacts is given the maximum temperature. | Copper alloy Sn over Ni Au over PdNi over Ni ent carrying capacity) maximum contacts including stinuous, non enectors when n, without exceeding | Electrical Load [A] | | All rights r Department EC P | ze DIN A3 1:1 eserved Created by HAGEMEYERE D - DE Title DIN power r | Inspected by Stand TADJE HOFFI | Sub. DS dardisation Date | Sta | ate nal Release Doc-Key / ECM 100580647/UGD/0 500000076069 |

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